

Commodore Single Disk Drive

Technical Manual

Model 1540/1541



C commodore
COMPUTER

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Chapter One

1.1 Scope

In this chapter, a description is made of the procedures necessary for servicing the Model 1540/1541 Floppy Disk Drive.

1.2 Unpacking

Special care should be exercised during unpacking not to damage the unit.

Unpacking procedures are as follows:

- a) Remove cardboard sleeve from styro-foam box
- b) Open 'styro-foam' box and remove drive
- c) Check the drives front door for proper operation

```
*****
*          Caution          *
*          *                  *
*  Do Not Use Magnetized Tools  *
*          *                  *
*****
```

1.3 Protection against noise

A weak signal from the media is detected in the head section of the drive. Hence, do not install the drive near a TV set or other areas where electromagnetic noise is generated. (i.e. motors, air-conditioners, etc)

1.7 Input/Output Cable

The length of the cable between the host and the drive (between the host and the last drive when the drives are daisy chained) should not exceed 5 meters (16 feet).

1.8 DC power source

The drive is powered by a internal power supply providing the drive with +12V and +5V.

1.9 Initial inspection

The drive can be briefly inspected for its operation by the following procedure. Install the drive, connect the power and I/O cables. Turn drive on and make sure the front panel power lamp is on. Proceed to step 2.2.

1.10 Outline of functions

The 1540/1541 Minifloppy Disk Drive mechanism is composed of the data read/write head, track positioning mechanism, spindle drive mechanism and eject mechanism.

1.11 Read/Write Head

The Read/Write head uses a glass-bonded, ferrite/ceramic head. Track-to-track erasing is accomplished by the straddle erase method. The surface of the Read/Write head is mirror-ground to minimize wear of the head and media. Also, the head is designed in such a way that the maximum signal can be obtained from the media surface.

1.12 Track positioning mechanism

Positioning of the Read/Write Head is accomplished by a stepping motor and steel belt. The stepping motor rotates clockwise or counter-clockwise by two steps per track. The control circuit on the logic board selects the direction and number of step to the desired track.

1.13 Spindle drive mechanism

The spindle drive motor operates on 12 VDC and turns the spindle, through a belt drive, at 300 revolutions per minute. The speed of the drive motor is controlled by a feedback signal from a tachometer which is housed in the drive motor assembly. The feedback signal controls a servo amp that supplies the 12 VDC drive current.

1.14 Eject mechanism

When the media is inserted in the Disk Drive and the door is closed the media is clamped by the spindle and hub. At this time the ejector mechanism is loaded by the insertion of the disk and locked. When the door is opened, the ejector mechanism is unlocked and the media pops out of the door.

Chapter Two

2.1 Mechanism Explanation

The 1540/1541 mechanism is installed in the system horizontally, however the drive will function if mounted vertically. The mechanical parts of the drive include an aluminum chassis, a stepping motor, head positioning assembly, drive motor, a hub and spindle assembly for centering and retaining the media during operation. The magnetic head is of a glass ceramic construction.

2.2 Function explanation

The drive is itself an independent memory device. The drive is composed of a media clamp rotating mechanism, ahead positioning mechanism and an eject mechanism. When the front door opens, the media can be inserted. All positioning operation excluding insertion and removal of the media are controlled by the internal guide mechanism. Closing the front door causes the media clamp mechanism to operate. Two operations are performed in the following order:

- a) The media is centered.
- b) The media is clamped and retained between the spindle and the hub.

The spindle and hub rotate at 300 r.p.m. through a closed-loop control circuit employing a D.C. motor/tachometer. It is important that the relationship between the head and the media is maintained correctly during operation. For this purpose, a pressure pad is used to hold and press down the media (about 12g) from the opposite side of the head, to maintain the correct contact with the head. This head assembly is coupled by a metal band to a four phase stepping motor the performs the track positioning. One step of the stepping motor corresponds to a 1/2 track movement. Use of a high-speed stepping motor and metal band drive, this series of disk drives can perform access operations at a very high speed.

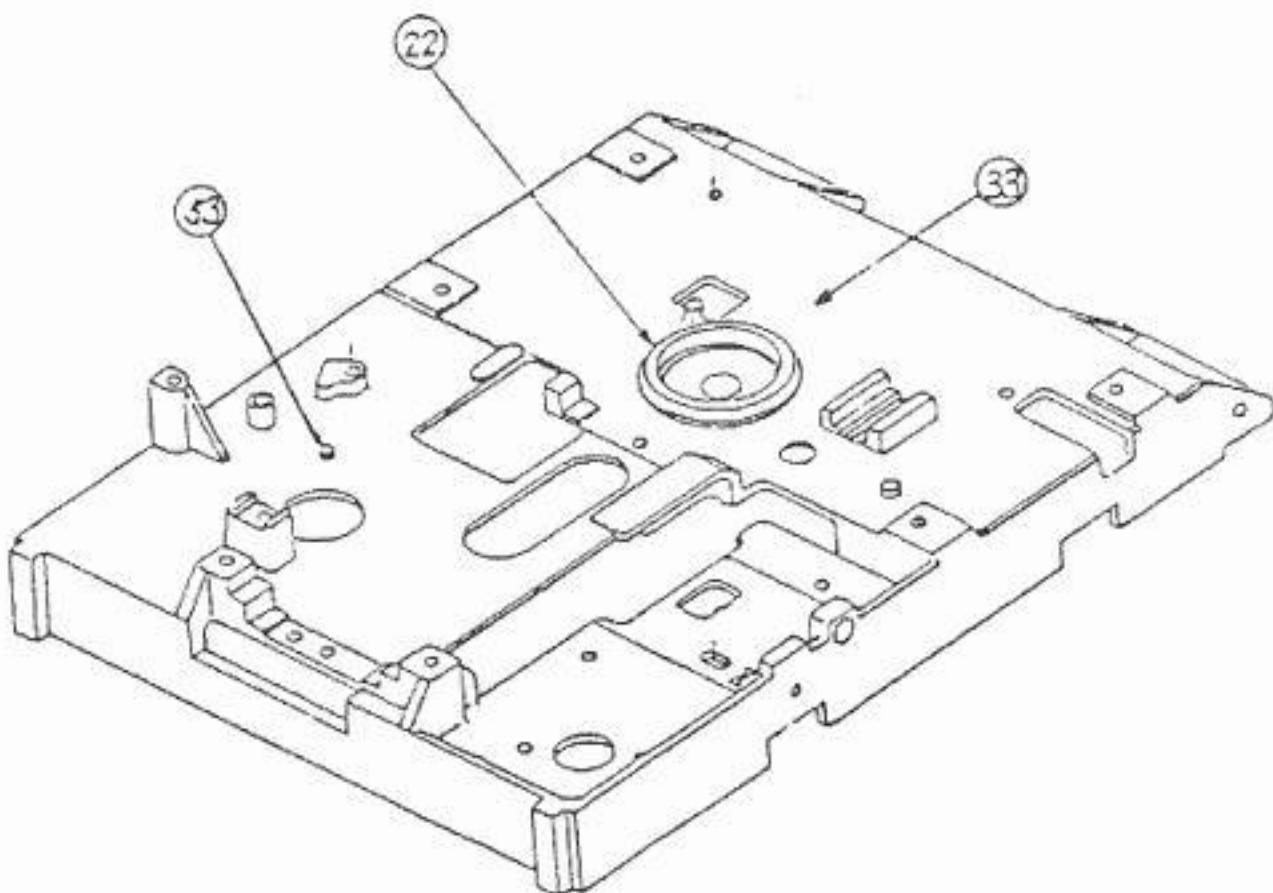
2.3 Assembly Procedure

2.3.1 The housing assembly; install the eject pin and the spindle.

2.3.2 The housing assembly; on the reverse side install the spindle pulley.

2.3.3 FIG 1, The housing unit.

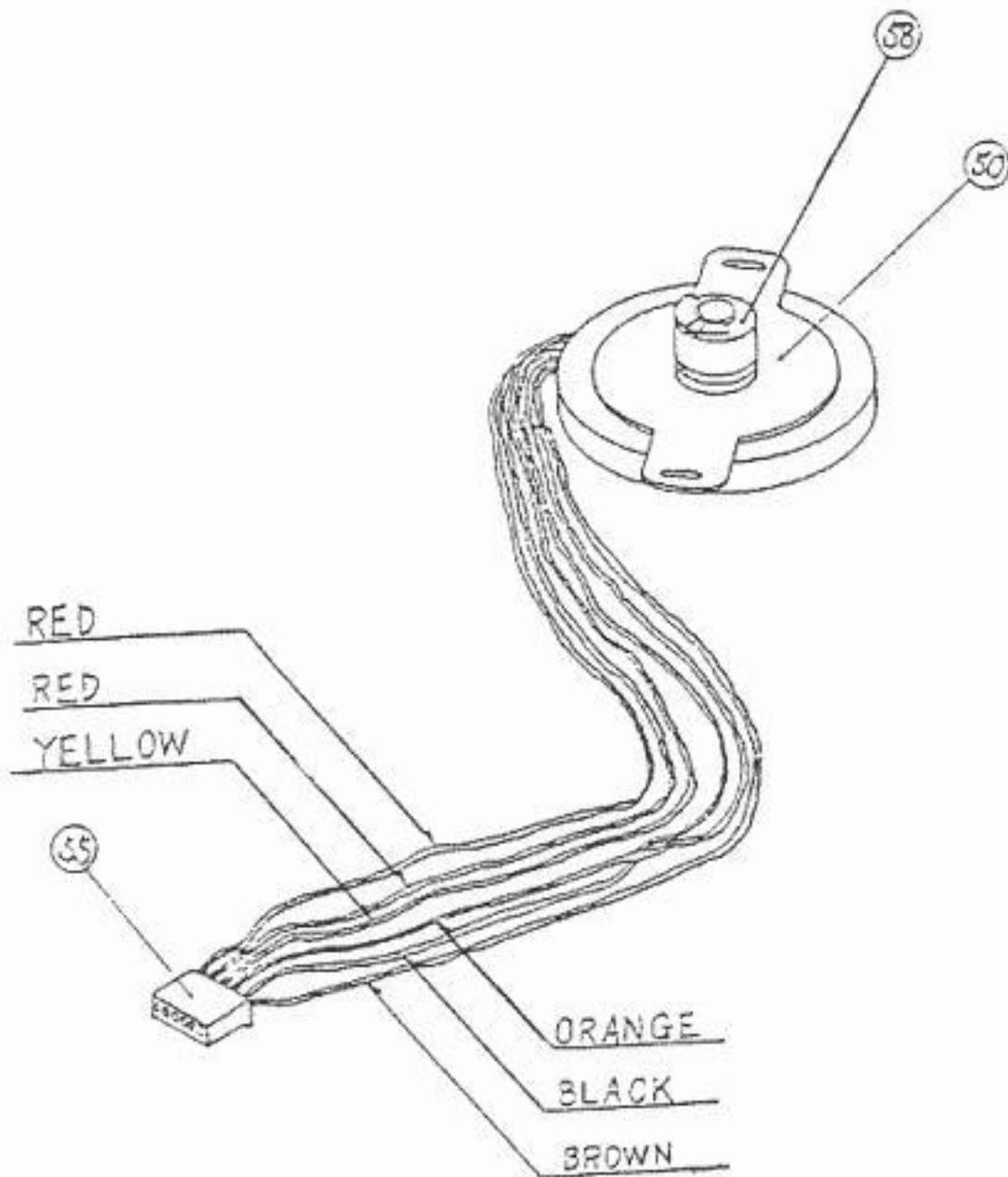
Part	Description
22	spindle
33	housing assembly.
53	eject pin



2.3.4 The stepping motor assembly; install the stepping pulley.

2.3.5 FIG 2, The stepping motor unit

Part	Description
50	stepping motor assembly
55	connector housing
58	stepper pulley



2.3.6 The D.C. motor assembly; install the motor pulley.

2.3.7 FIG 3, D.C. motor and control PCB

Part	Description
44	motor control PCB
48	D.C. motor
51	connector housing
59	D.C. motor pulley

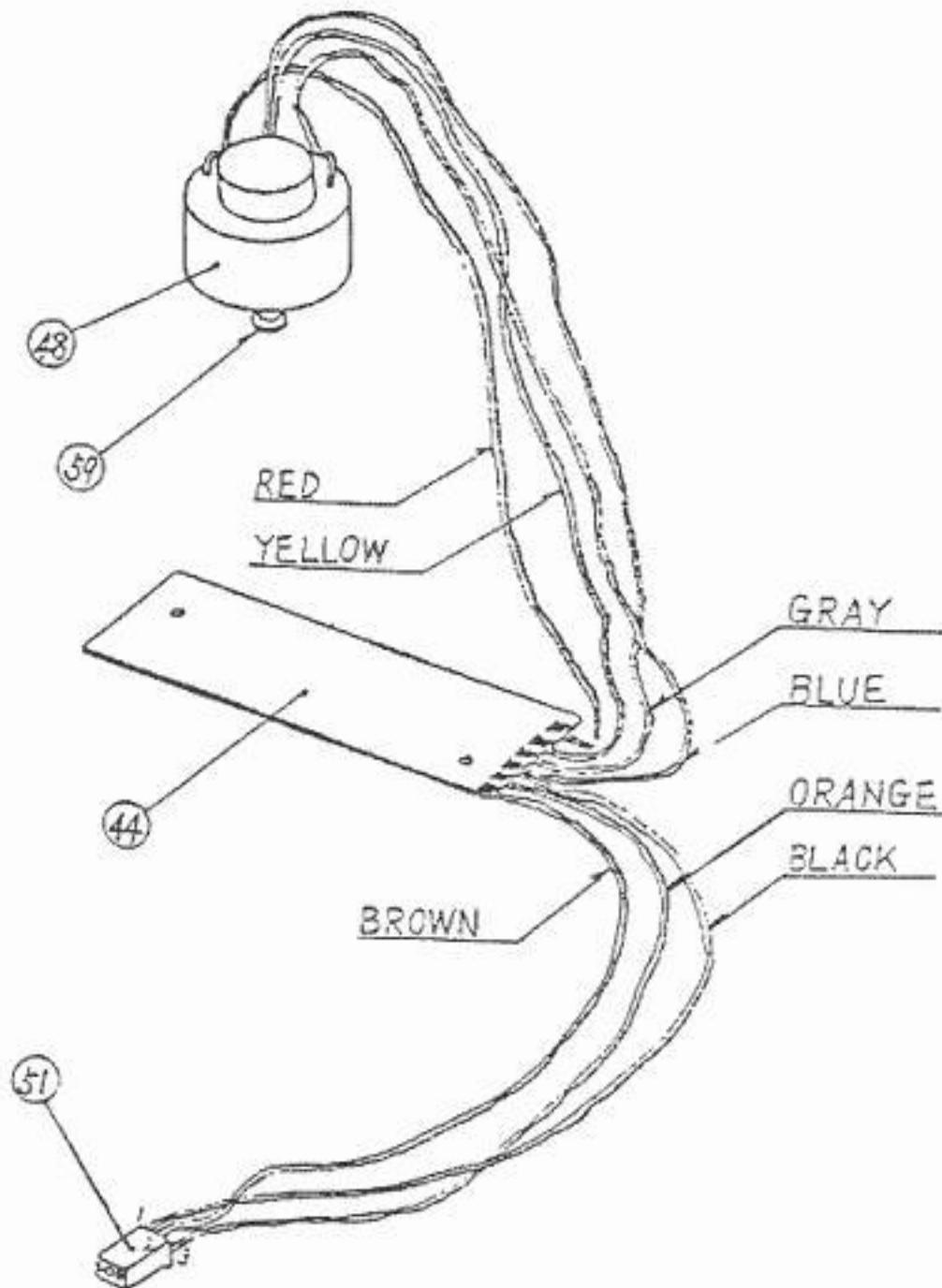


FIG. 6

Part	Description	Part	Description
20	binder screw	37	washer
21	diskette guide	38	eject spring
28	LED clamp	39	eject plate
29	front panel	40	slider
30	Flush screw	43	diskette guide
31	LED assembly	52	connector housing
32	LED holder ring		

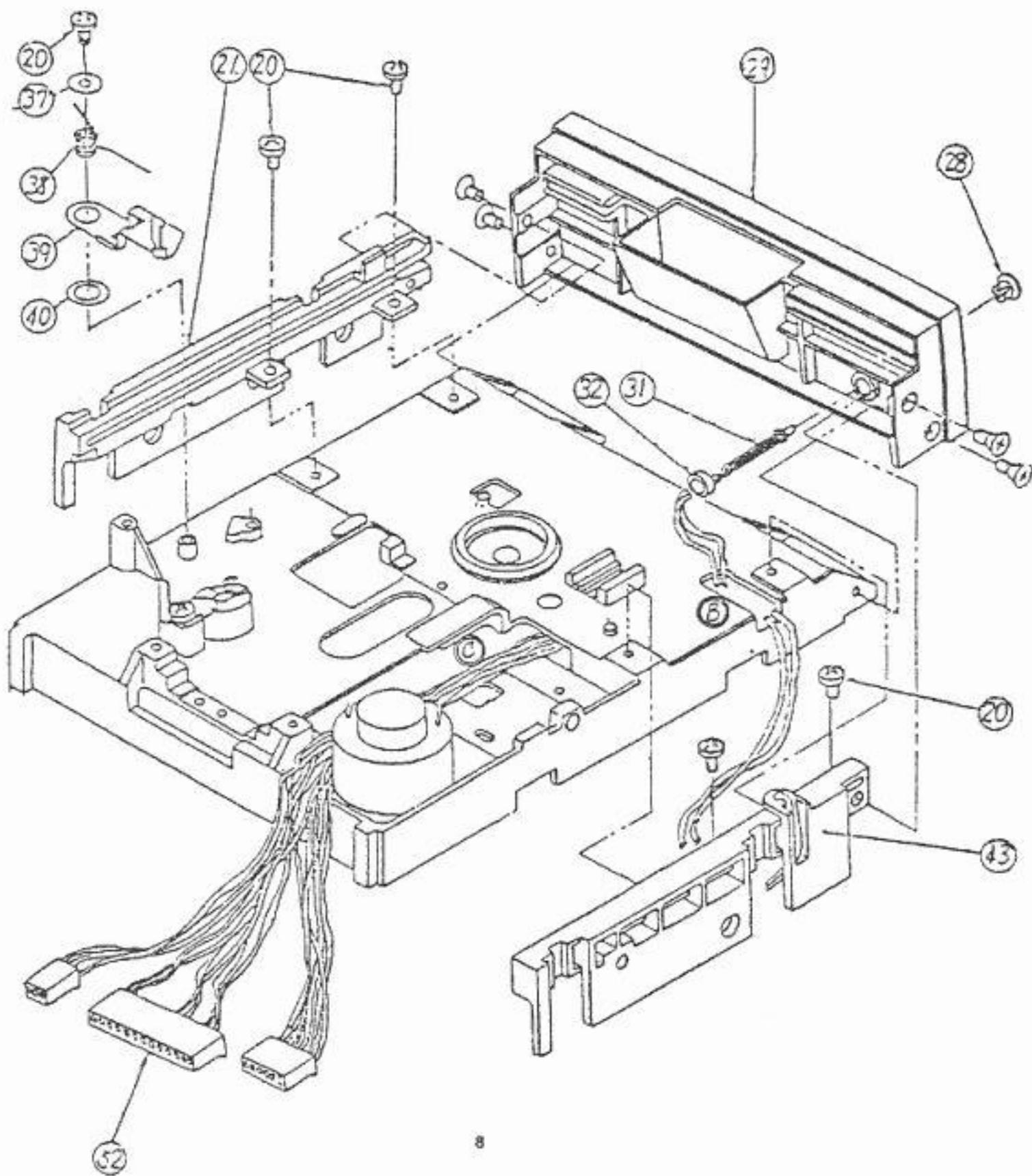


FIG 7.

Part Description

- 15 binder screw
- 18 binder screw
- 24 tension pulley
- 25 guide shaft keeper
- 26 guide shaft
- 34 metal band
- 35 washer
- 36 head assembly
- 56 tension spring

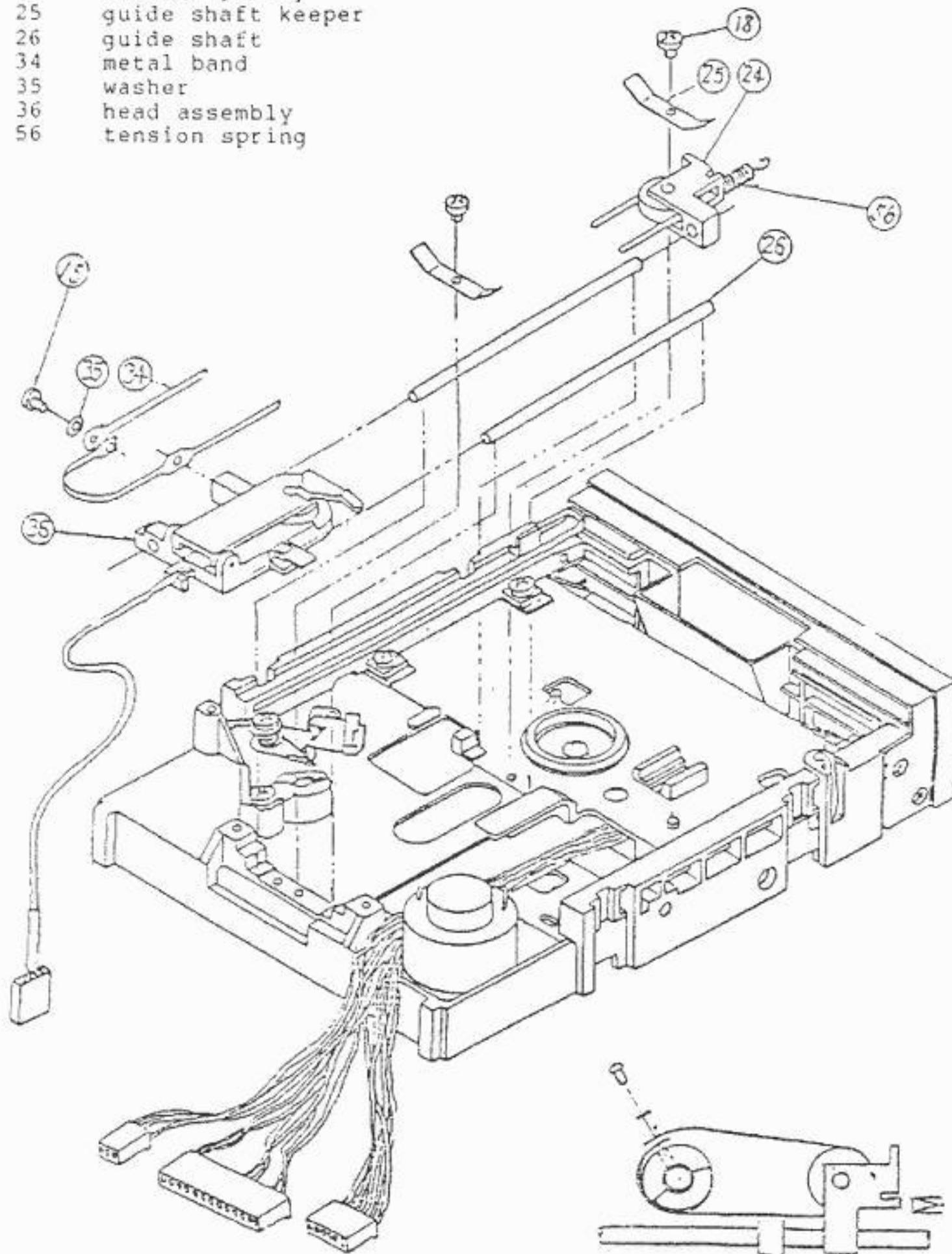


FIG 8

Part Description

- 20 binder screw
- 45 cable clamp
- 49 cable ties

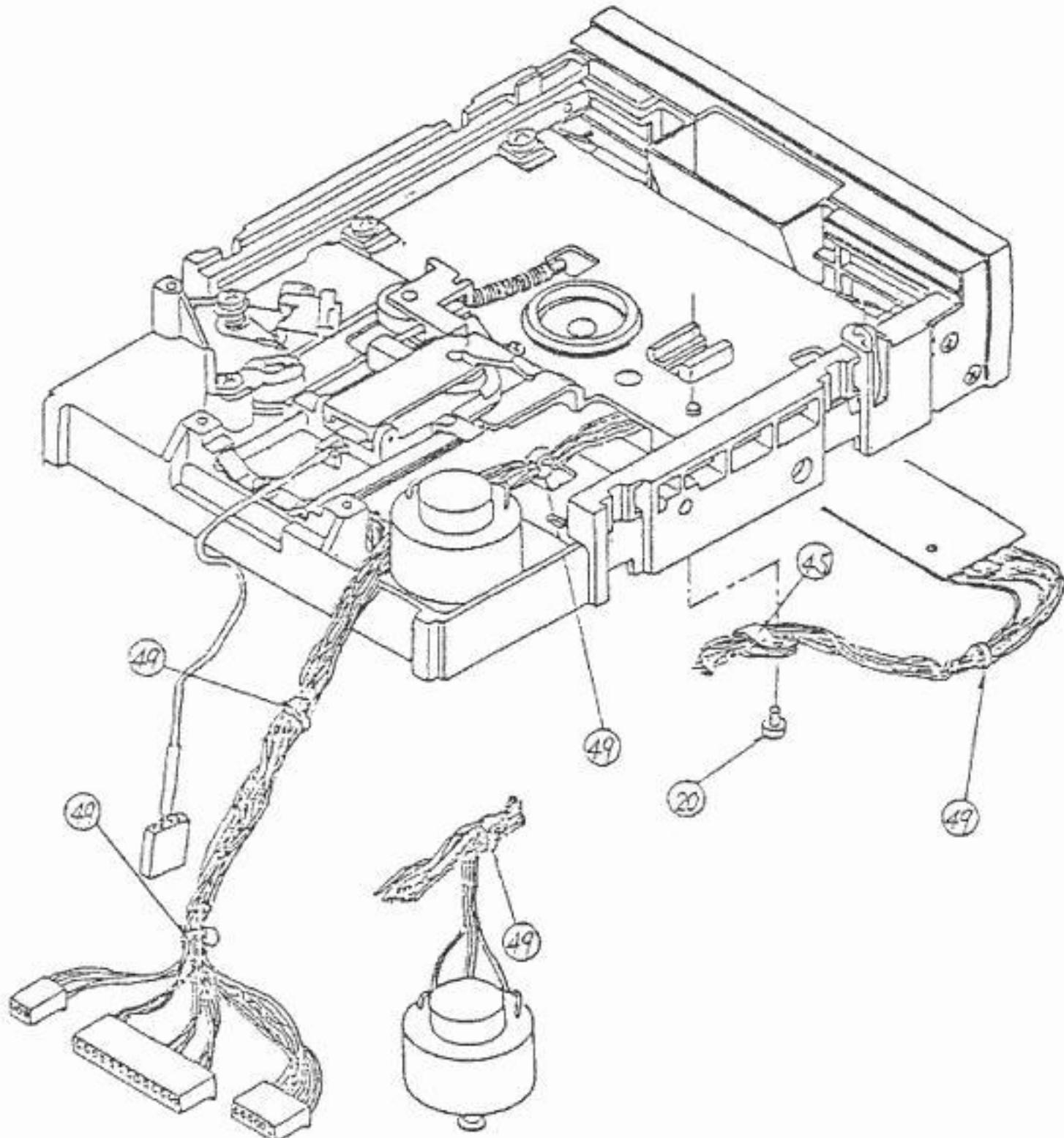
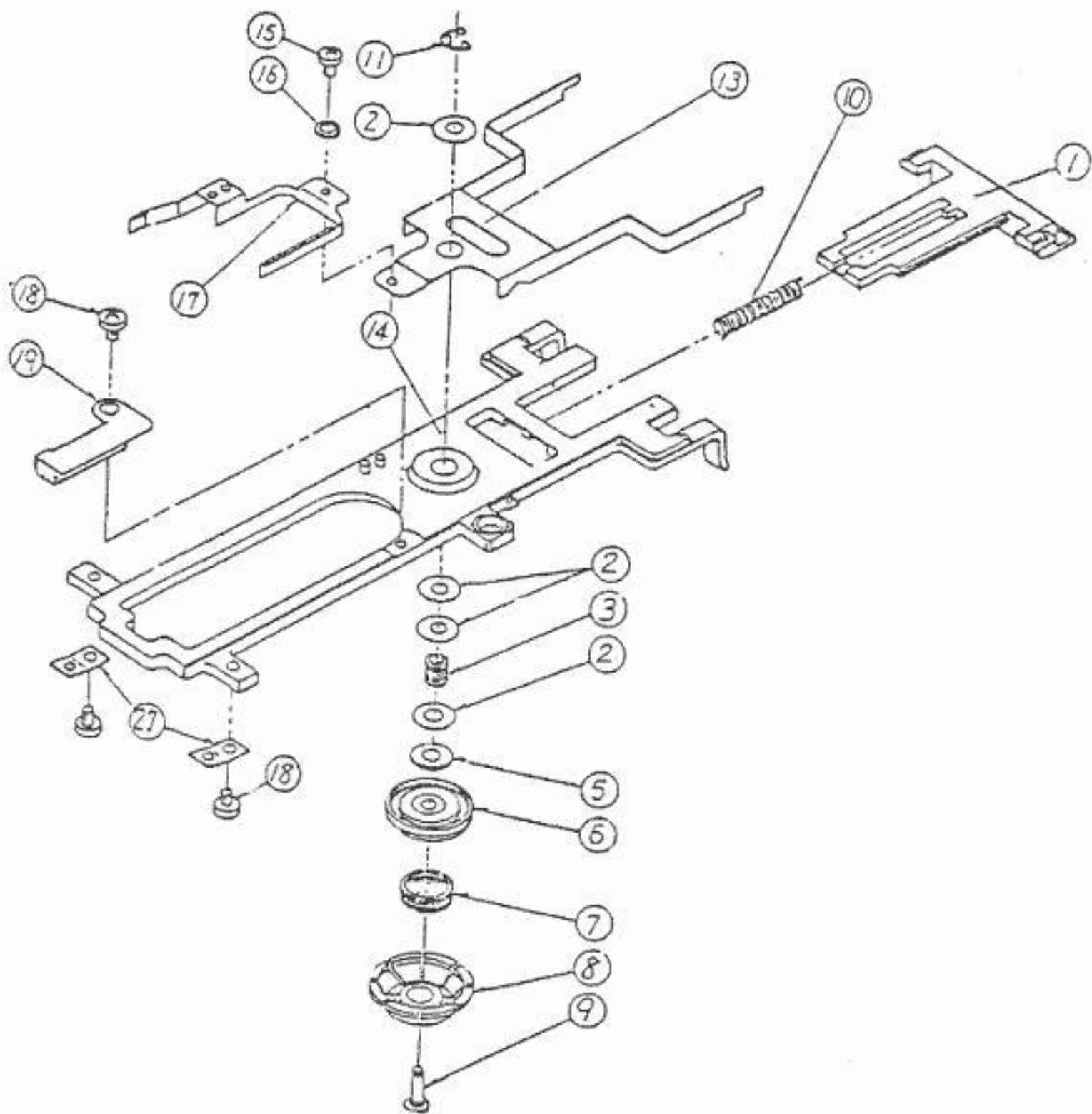


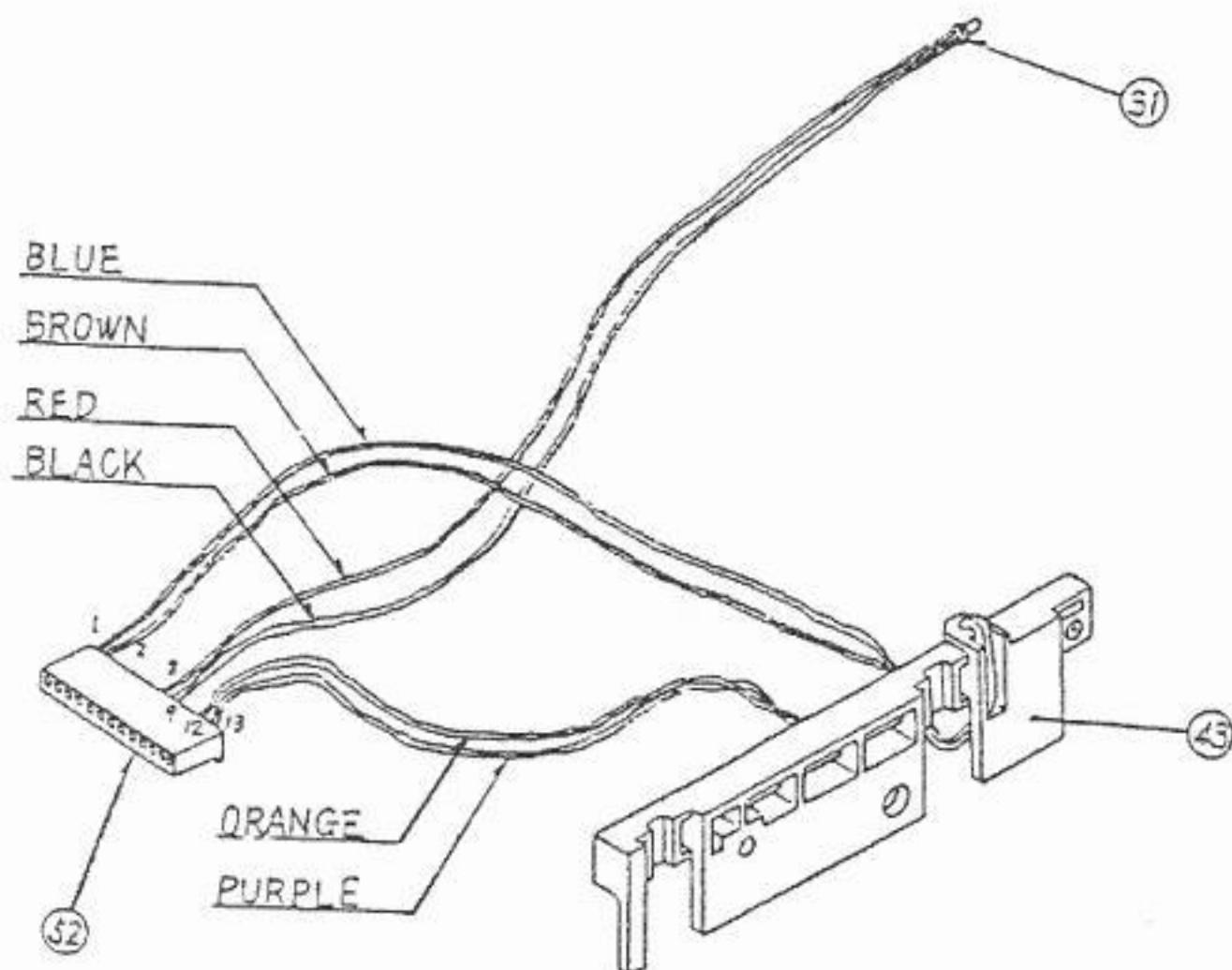
FIG 9

Part	Description	Part	Description
1	door assembly	13	hub support
2	collar	14	hub frame
3	clamp spring	15	binder screw
5	thrust washer	16	spring washer
6	collet assembly	17	arm support assembly
7	hub spring	18	binder screw
8	hub	19	pad plate assembly
9	hub shaft	27	hinge spring
10	door spring	60	collet
11	E-washer	61	collet bearing



2.3.8 FIG. 4, Diskette guide, LED assembly and connector housing.

Part	Description
31	LED assembly
43	diskette guide
52	connector housing

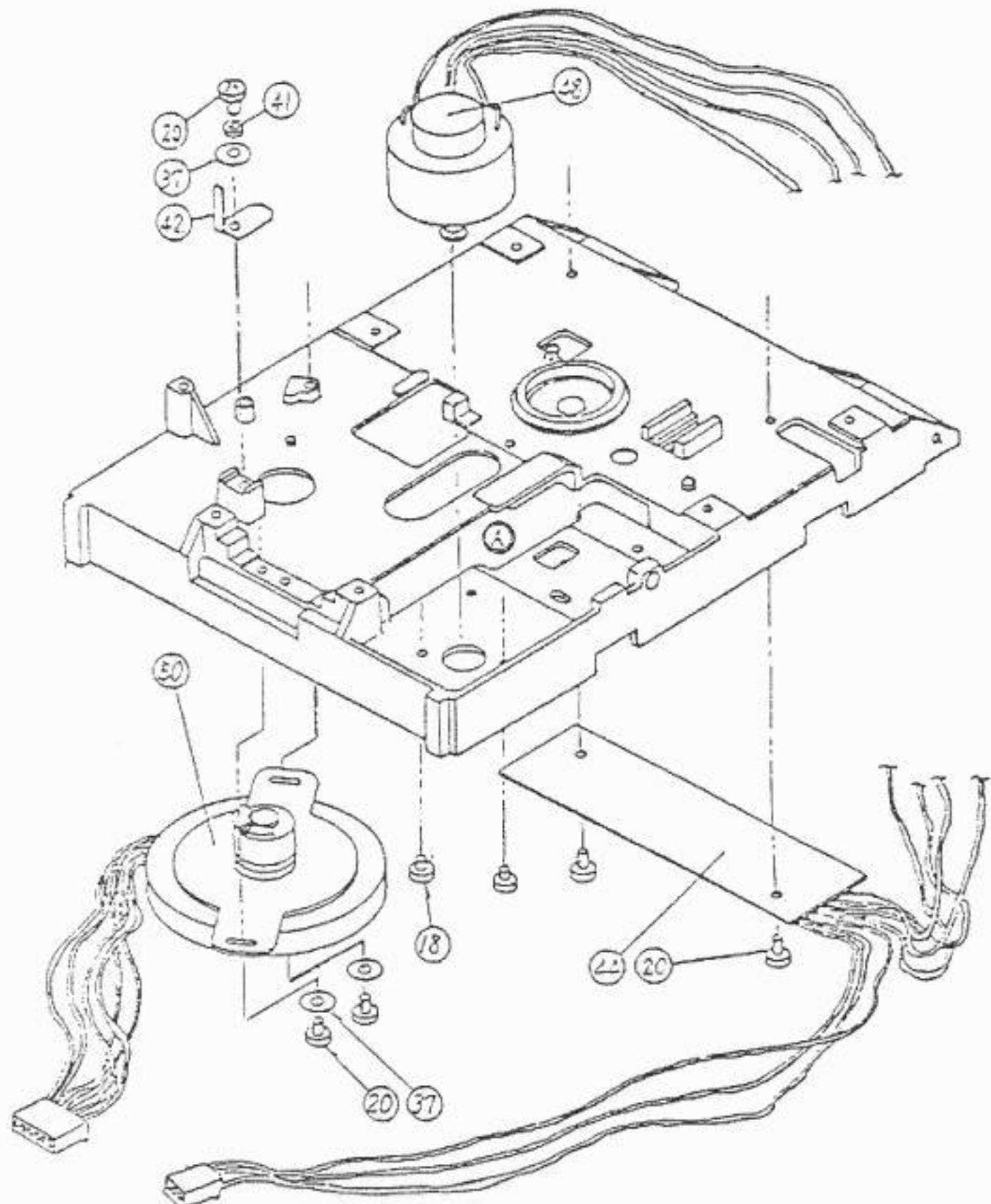


- 2.3.9 Secure the D.C. motor from the reverse side of the housing assembly with two screws.
- 2.3.10 Put the motor control PCB into hole 'A' and secure it with two screws.
- 2.3.11 Secure the stepping motor with two screws.
- 2.3.12 Secure the carriage stopper with a screw.
- 2.3.13 Install the connector housing '52' into the hole 'B' and remove through hole 'C'.
- 2.3.14 Secure the two diskette guides '21' and '43' with two screws each.
- 2.3.15 Install the LED holder in the front panel.
- 2.3.16 Insert the LED assembly into the LED holder ring.
- 2.3.17 Install the led into the LED holder, then push the LED holder ring onto the LED holder.
- 2.3.18 Attach the front panel with four flush screws.
- 2.3.19 Secure the eject plate with a screw.
- 2.3.20 Wind the metal band around the tension pulley.
- 2.3.21 Insert the guide shafts into the head assembly. Install the tension pullet as shown in figure 8
- 2.3.22 Secure the guide shaft keepers by two screws each.
- 2.3.23 Wind the metal band around the stepper pulley and secure it with a screw to the stepper motor pulley.
- 2.3.24 Hook the spring to the tension pulley and install unit in the slot in the housing assembly.
- 2.3.25 Hook the opposite end of the spring to the housing assembly.
- 2.3.26 Fasten cable ties to the cables.
- 2.3.27 Secure the cable clamp with a screw as shown in FIG 8.
- 2.3.28 Secure the arm support assembly with a screw to the hub support.
- 2.3.29 Insert the hub shaft into the hub, the hub spring, the collet assy, the thrust washer, the collar, the clamp spring and two collars.
- 2.3.30 Insert the hub shaft into the frame and the hub support and fasten it at the E-washer.
- 2.3.31 Set the door assembly and the door spring at the hub frame.
- 2.3.32 Secure the pad plate assembly with a screw to the frame at the location shown in FIG 9
- 2.3.33 Secure the two hinge springs with two screws each.

FIG. 5

Part Description

- 18 binder screw
- 20 binder screw
- 37 washer
- 41 spring washer
- 42 carriage stopper
- 44 motor control PCB
- 50 stepping motor assembly



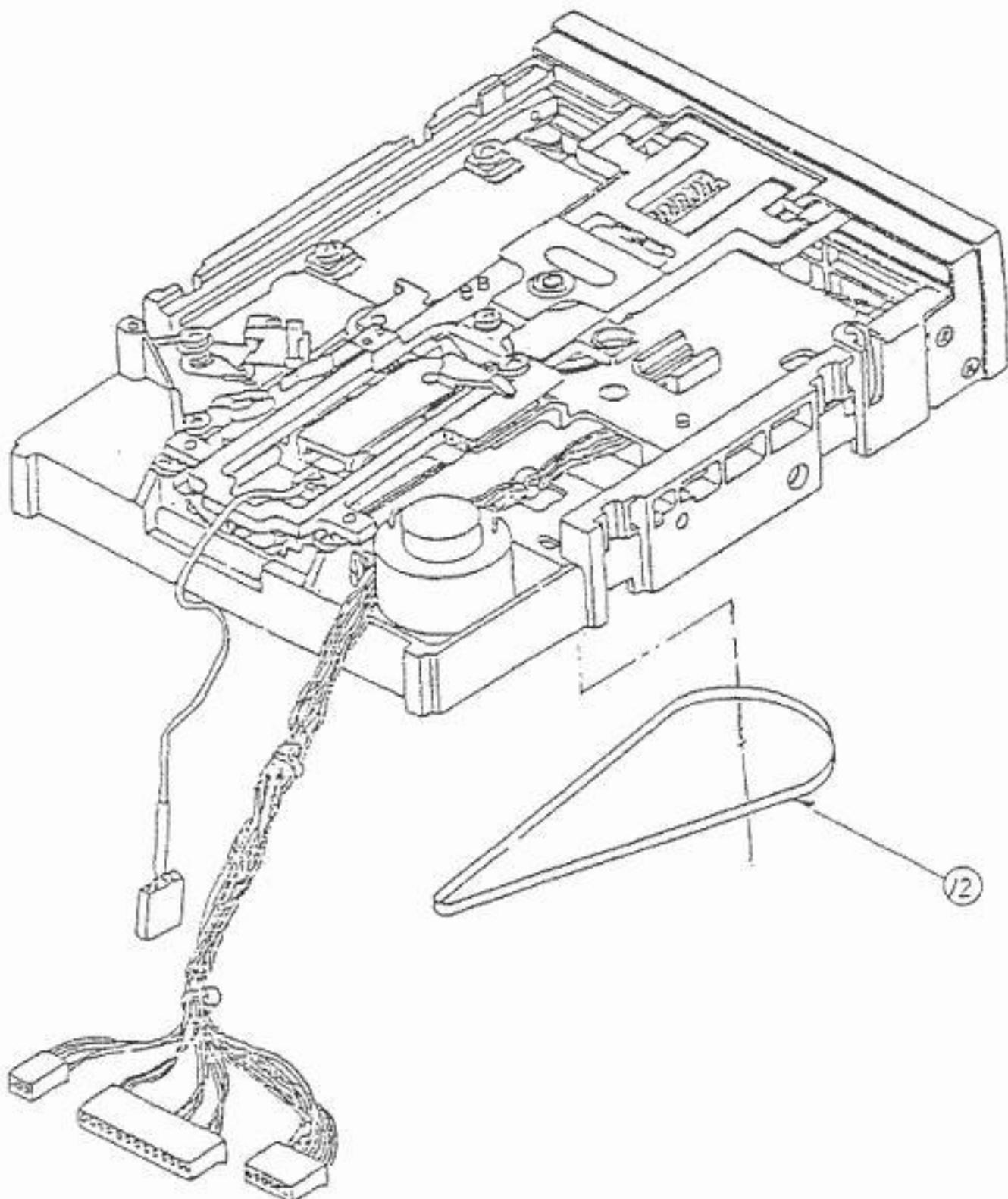
2.3.36 Place the belt over the D.C. motor pulley and partially on the spindle pulley.

2.3.37 By turning the spindle pulley the rest of the belt will seat completely on the pulley.

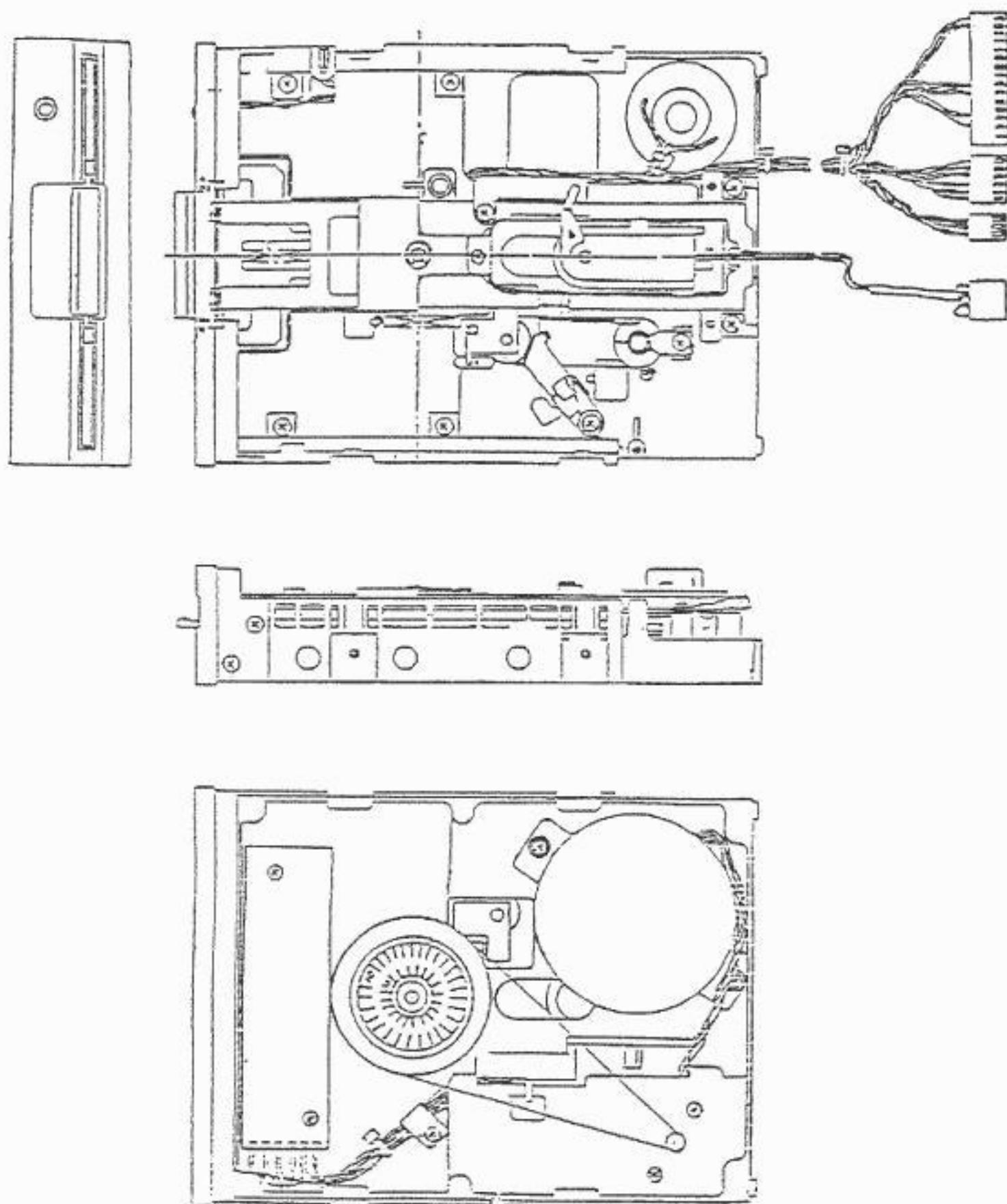
2.3.38 FIG 10

Part Description

12 drive belt



2.3.39 FIG 11; Completed Drive Mechanism



3.1 Description

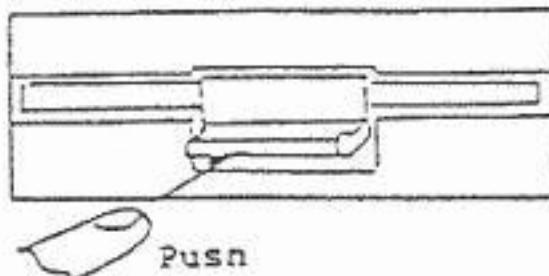
Since the disk drive is placed under direct control of the interface and power supply, no special procedure is required for starting and operation.

3.2 Operating procedure

Make sure that the power supply and I/O connector are connected, then insert the disk in accordance with the following procedure.

3.2.1 Inserting the media

- a) Apply DC voltage to the drive.
- b) Open the front door.



- c) With the index hole and write protect notch being placed on the left side of the jacket, push the media in, when the media is fully inserted the locking action can be felt.
- d) Push the door downward and close the door so that it is locked firmly

3.2.2 Extracting the media

- a) Open the front door. The media will pop out automatically to a position where you can extract it easily.
- b) For protection of the recorded data, the media should always be stored in its envelope.
- c) Close the door of the drive.

3.3 Media handling procedure

Since the media has been subjected to a write operation it naturally contains information, adequate attention must be paid to its handling.

In order to extend the life of the media and eliminate the causes of errors, it is best to take the following steps:

- a) When writing something on the jacket label of the media, do not use a ball point pen or pencil, use felt-tipped pens.
 - b) Do not hold the edges of the media with paper clips or the like.
 - c) Do not touch the media exposed in the slot of the jacket.
 - d) Do not attempt to clean the media.
 - e) Do not keep the media in the areas where there is a strong magnetic field.
 - f) The diskette should be kept in its jacket.
 - g) Special care should be exercised so that the media is kept free from liquid, dust, metal particles, etc.
- b) Take care not to exceed the following environmental conditions:

Temperature 10 to 51°C
Relative humidity 8 to 80 %

3.4 Seek error

Few seek errors will be experienced due to the low stepping rate, less than 12 msec/track. In case of a seek error, however, recalibration of track position can be performed. This can be done by repeatedly stepping the head towards track 0 until track 0 status is detected.

3.5 Write error

In order to check the quality of the data, perform a read-after-write operation. When data can not be read, rewrite that track and sector once again.

When data can not be read after four such operations track is defective.

3.6 Read error

What happens quite often when performing a read operation is a soft error. A soft error is defined to be a read error which is recoverable by making ten or less read operations. However, in the event no recovery is made in ten operations, move one step from the track in the same direction as the previous step, then return one step. If this fails to read the data, this error is unrecoverable.

3.7 Description

Periodic maintenance is indispensable so that this type of peripheral equipment operates properly. It is particularly important to periodically clean the head and check the load pad. Repairs and adjustments should be made in accordance with the procedures below.

3.8 Head Cleaning

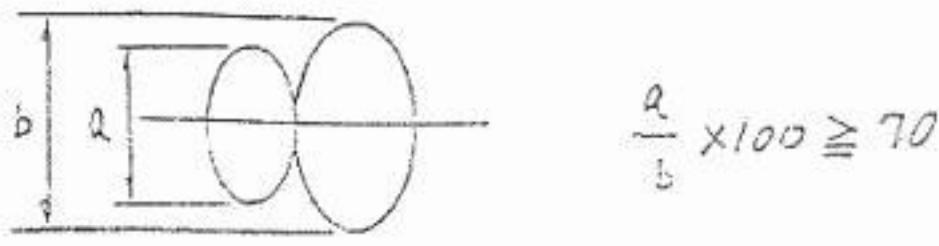
Check for excessive dust or magnetic oxide on the load pad. With the door open (do not move upper arm greater than what is provided by opening the front door) clean head with lint free cotton cloth or 'Q-tip' in 91% isopropyl alcohol. Wipe the head carefully to remove any dust and/or oxide.

3.9 Adjustment procedure

In case of a malfunction or parts replacement, make the following adjustments. In order to maintain the interchangeability of the media between drives it is desirable check each drive against a master alignment diskette.

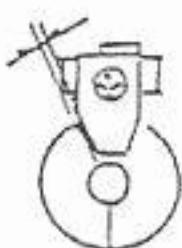
3.9.1 Track adjustment (radial track)

- a) Connect I/O cable and restore the head to track 00.
- b) Insert a 48tpi alignment diskette and close the door.
- c) Connect two oscilloscope probes to pin 1 and pin 14 of UH6 (592), set oscilloscope to analog add at 50mV/cm and 200 msec/div.
- d) Load the head and allow it to seek to track 16, check for cat's eye wave form. When the cat's eye lobe ratio is 70% or less, loosen the stepping motor mounting screws, turn the stepping motor to obtain the lobe ratio of 90% or less.
- e) After allowing the head to track 34, return it to track 16 and recheck the cat's eye. If the ratio is correct tighten the stepping motor screws.



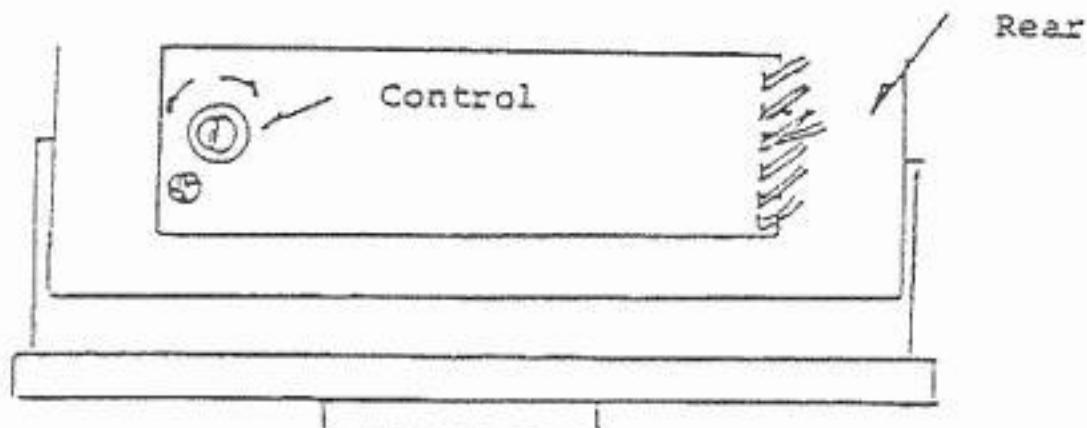
3.9.2 Track 00 adjustment

The drive is not provided with a track 00 sensor. To adjust, let the head over step in the track 00 direction and adjust the limiter position to obtain a clearance less than 0.25mm (0.01inches).



3.9.3 Speed control

Turn the variable resistor on the motor control board until the tachometer disk on the spindle pulley appears stationary when viewed with a fluorescent lamp.



PART NO.	DESCRIPTION																				
1540048-01	PCB ASSY. VIC-1541. USED LOGIC ARRAY FCC (UL)																				
<table border="1"> <thead> <tr> <th>LTR ZONE</th> <th>REVISIONS</th> <th>DESCRIPTION</th> <th>DATE APPROVED</th> </tr> </thead> <tbody> <tr> <td>Q4004</td> <td></td> <td></td> <td></td> </tr> <tr> <td>A</td> <td></td> <td>PRODUCTION RELEASE</td> <td>10/12 T. Tokunaga</td> </tr> <tr> <td>B</td> <td></td> <td>REVISED PER ECO 830085</td> <td>12/9/83 J. G. L.</td> </tr> <tr> <td>C</td> <td></td> <td>REVISED PER ECO 830125</td> <td>3/5/84 J. G. L.</td> </tr> </tbody> </table>		LTR ZONE	REVISIONS	DESCRIPTION	DATE APPROVED	Q4004				A		PRODUCTION RELEASE	10/12 T. Tokunaga	B		REVISED PER ECO 830085	12/9/83 J. G. L.	C		REVISED PER ECO 830125	3/5/84 J. G. L.
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C		REVISED PER ECO 830125	3/5/84 J. G. L.																		
<p style="text-align: center;">(1540048-01)</p>																					

DRAWN BY		DATE	ENGR	
T. Tokunaga		11/16/82		
CHKD			APPR.	T. Matsuo To

SHEET / OF 8		SIZE	SHEET / OF 8
		B	

1. SHEET 7 & 8 OF 8 ARE B-SIZE
ASSY DWG
NOTES- UNLESS OTHERWISE SPECIFIED:

QUANTITY REOD PER PART / DASH NO.	#	8	PART NUMBER	DESCRIPTION	REF DES	QTY	NOTES	
							20	10
1	1	B	1540050	PC BOARD 238 x155 x1.6t			GLASS EPOXY.	G-10
2								
3								
4								
5	C	1540049-01	SCHEMATIC DIAGRAM	USED LOGIC ARRAY. FCC (u)				
7								
8								
9								
10								
11								
12	B	901435-01	IC MPS 6502	CPU	UC4			
13	1	901437-01	MPS 6522	VIA	UC2, UC3			
14	901229-03	2364-197	ROM	UB4	\$E000 ~ \$FFFF			
15	325302-01	2364-190	ROM	UB3	\$C000 ~ \$DFFF			
16	325572-01	LOGIC ARRAY	40 PIN DIP	UC1				
17	901521-01	74LS00	2-NAND	UC6				
18	901521-17	74LS42	DEC.	UC7				
19	901522-01	7417	BUFFER	UD2				
20	901521-32	74LS86	2-EX-OR	UD3				
21	901522-06	7406	INV. BUF.	UB1, UD1				
22	901521-02	74LS04	INV.	UC5				
23	901521-30	74LS14	SCH. INV.	UA1				
24	901521-26	74LS193	4 BIT. COV.	UE6				
25	901521-54	74LS197		UD5				
26	901522-03	74177		UD5				
27	901510-01	9602		UD4				
28	901523-04	LM311		UE4				
29	B	901523-08	IC NE592	UF3, UF4				
30	B	3255502-03	TMH12016P	RAM	UB2			
31	B	3255502-01	H5872SP	RAM	UB2			
32	B	901522-30	IC 7407	UD2				
33								
34								
35								
36								
37								
commodore		PCB ASSY. VIC-1541		DRAWN BY: T. T. Kudela CWB	DATE: 11/16/82 APPR: T. H. 1540048	PART NO: B	REV C	SH- 8

QUANTITY REQD PER PART/ DASH NO.	REF	QTY	PART NUMBER	DESCRIPTION	REF DES	QTY	NOTES
01							
2	38	B	902671	TRANSISTOR NPN 2SC945	Q2.Q7		
S	39		902693-01	2SC18/S	Q2.Q7		SUBSTITUTE FOR ITEM 38.
4	40		902679	2SD467	Q8-Q11		
S	41		902682	NPN 2SC2120	Q8-Q11		SUBSTITUTE FOR ITEM 40.
/	42		902720	PNP 2SA673	Q1		
4	43		902717	2SA733	Q3-Q6		
S	44	B	902744-01	TRANSISTOR PNP 2SA105	Q3-Q6		SUBSTITUTE FOR ITEM 43.
	45						
	46						
	47						
	48						
	49						
	50						
	51						
6	52	B	900750-02	DIODE, RECTIFIER 1N4002	CR24.B-11		
8	53		900850-05	SIGNAL W6713C	CR67124-B		
S	54		900850-01	SIGNAL 1N4148	CR67124-B		SUBSTITUTE FOR ITEM 53.
/	55		325505-01	ZENER 3.3V 500mW ±5%	CR5		H23C-2
S	56		325505-02	3.3V 500mW ±5%	CR5		H24A-1
S	57		900948-06	3.3V 500mW ±5%	CR5		IN5226B
/	58		325506-01	5.1V 500mW ±5%	CR13		H25C-2
S	59		900948-11	ZENER 5.1V 500mW ±5%	CR13		IN5231
2	60	B	900756-01	DIODE ERIDGE 1.5A 50V	CR1.CR3		K8P-005
	61						
	62						
	63						
/	64	B	325566-01	CRYSTAL MODULE 16MHz 50PPM	Y1		
S	65	B	325566-02	CRYSTAL MODULE 16MHz 100PPM	Y1		SUBSTITUTE FOR ITEM 64.
	66						
	67						
	68						
/	69	B	325513-01	COIL, INDUCTOR 2.2μH	L1		
2	70	B	325513-02	COIL, INDUCTOR 22μH	L9,L10		
3	71	B	325513-03	COIL, INDUCTOR 100μH	L8,L11,L12		
	72						
	73						
	74						
commodore		PCB ASSTY.	VIC-1541	DRAWN BY: T. Takemoto CHKD:	DATE: 1/14/82 APPR: TJA	SIZE: 127/2 127/2	REV B C 3/8

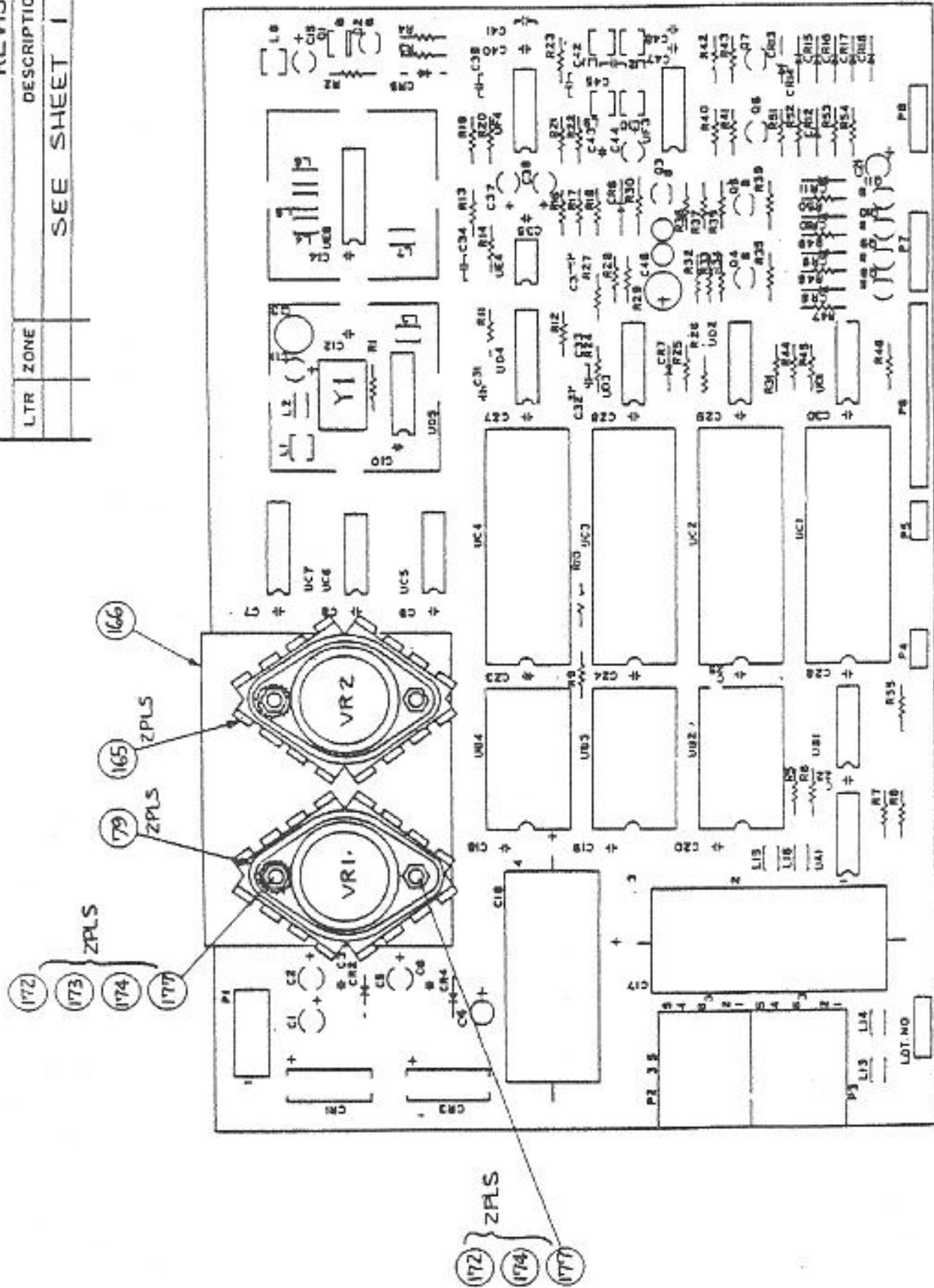
QUANTITY	REF. NO.	PART NUMBER	DESCRIPTION	REF. DES.	QNTY	NOTES
01						
1	76 B	901528-04	VOLTAGE REGULATOR 12V, 1.5A	VR1	1	LH 340-12 TO -3
1	76 B	901528-03	VOLTAGE REGULATOR 5V, 1.2A	VR2	1	LH 340-5 TO -3
1	77					
1	78					
2	79 B	904914	INSULATION MILAR TO -3			
5	80 B	325551-01	INSULATION SILICONE TO -3			SUBSTITUTE FOR ITEM 79.
81						
2	82 B	903361	CONNECTOR, DIN 6P	P2, P3		
1	84					
1	85					
1	86					
4	87 B	904150-06	SOCKET IC LOW PRO 40 PIN			
3	88 B	904150-03	SOCKET IC LOW PRO 24 PIN			
1	89					
	90					
	91					
	92					
	93					
	94					
	95					
1	96 B	251065-04	HEADER ASSY. 2.5 PITCH 4 PIN	P8	1	MOLEX 50408-04 A4
1	97	325562-06		P7	1	3022-06 A
1	98	325562-15		P6	1	3022-15 A
2	99	325562-03	2.5 PITCH 3 PIN	P4, P5	2	3022-03 A
1	100 B	903316-04	HEADER ASSY. 3.96 PITCH 4PIN	P1	1	MOLEX 5271-04 A
	101					
	102					
	103					
	104					
	105					
	106					
	107					
	108					
	109					
	110					
	111					
commodore PCB ASSY. VIC-1541				DRAWN BY: 7.7.1982 APPR: T.M. CHKD:	DATE: 7/1/82 12/18	SIZE: B 1540048 C 4/8

QUANTITY RECD PER PART / DASH NO.	#	#	#	PART NUMBER	DESCRIPTION	REF DES	QTY	NOTES
						01	02	
	1	112	B	900301-04	CAPACITOR ELECT.	220 μ F/10V	C13	
	1	113	1	900/01-45		6800 μ F/25V	C17	
	1	114	1	900/01-32		4700 μ F/16V	C16	
2	115	1	900/00-33			47 μ F/16V	C2,C5	
2	116	1	900/00-32	ELECT.		1 μ F/25V	C1,C4	
1	117	1	900402-15	TANTALUM		10 μ F/25V	C15	
1	118	1	900402-11	TANTALUM		3.3 μ F/25V	C44	
1	119	1	9000/0-52	CERAMIC		150 μ F/50V	C31	$\pm 5\%$
2	120	1	-53			330 μ F/50V	C32,C36	$\pm 5\%$
3	121	1	-54			680 μ F/50V	C45,C33,C34	$\pm 5\%$
1	122	1	-25			1000 μ F/50V	C41	
24	123	1	-20			0.1 μ F/50V	C3,6-10	14,16,19,20,22-30,35,40,43,47,48
2	124	1	9000/0-14	CERAMIC		0.022 μ F/50V	C39,C42	
1	125	1	900/00-40	ELECT.		100 μ F/16V	C46	
2	126	1	900402-17	TANTALUM		0.47 μ F/25V	C37,C38	
1	127	1	-08			4.7 μ F/25V	C21	
1	128	1	900402-14	TANTALUM		1 μ F/16V	C11	
1	129	B	900465-02	CAPACITOR CERAMIC		0.033 μ F/25V	C12	
130								
131								
132								
133								
1	134	B	901550-56	RESISTOR CARBON	$\frac{1}{4}$ W $\pm 5\%$	47 Ω	R1	
2	135	B	901550-108	RESISTOR CARBON	$\frac{1}{4}$ W $\pm 5\%$	360 Ω	R14,R24	
4	136	1	-89			150 Ω	R17,R45,R46	
4	137	1	-52			220 Ω	R4,16,36,55	
2	138	1	-14			390 Ω	R3,R23	
6	139	1	-58			470 Ω	R10,R22,R37,R38	41
1	140	1	-38			5/0 Ω	R27	
6	141	1	-31			680 Ω	R14A2,R1-50	
6	142	1	-01			1 $k\Omega$	R25,R37,R43	
3	143	1	-53			2 $k\Omega$	R9,10,26	
6	144	1	-18			2.2 $k\Omega$	R11,R21,R2-34	
1	145	1	-69			1.5 $k\Omega$	R40	
4	146	1	-12			22 $k\Omega$	R12,R35,R32	
2	147	B	901550-07	RESISTOR CARBON	$\frac{1}{4}$ W $\pm 5\%$	100 $k\Omega$	R25,R44	
148								
commodore PCB ASSY. VIC-1541						DRAWN BY: T. Z. Kuhn CHKD:	DATE: 11/14/82	ENGR: 1/10 APP'D T.M. SIZE: 1/2" x 1" REV: C SHT: 5/8

REVISIONS		DESCRIPTION	DATE	APPROVED
LTR	ZONE			
		SEE SHEET 1		

REVISED

DESCRIPTION SEE SHEET

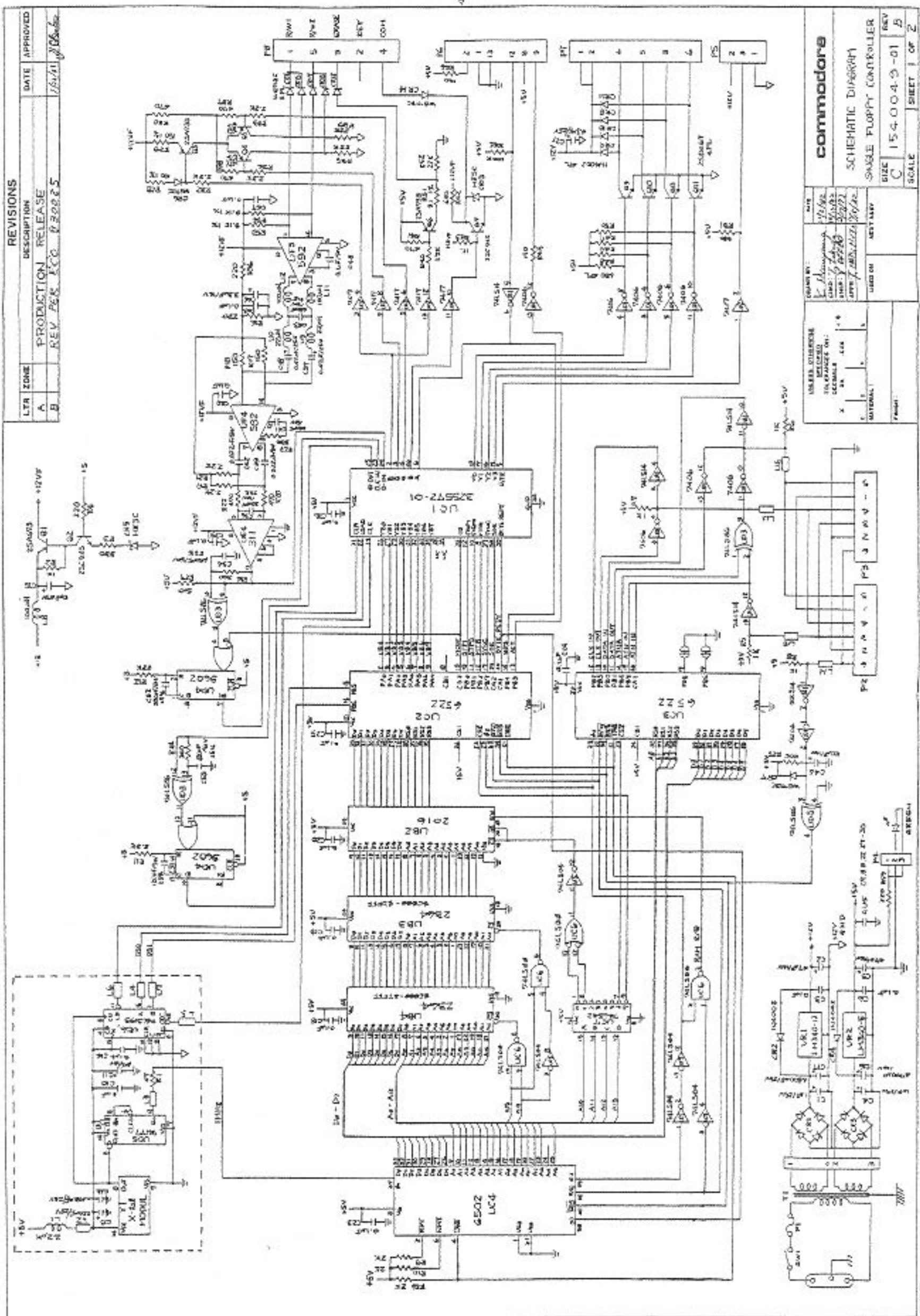


commodore

C.C.B ASSY
VIC-1541

REV C
1540048-01

HOME STREET 7 OF 8



PART NO.	DESCRIPTION	B	C	D	E	F	G	H	I	J	K	L	M	N	O	P	Q	R	S	T	U	V	W	X	Y	Z	AA	BB	CC	DD	EE	FF	GG	HH
1540001 -01	PCB ASSY V1C-1540 (FCC) UL	A	5/24/81	PRK(D)D110/J	REVISION																													
		B	5/24/81	ADDED SHEET 6 OF 7 (FOR FCC)																														
		C	8/3/82	ADDED DASH -03 AND -04																														
		D	9/20/82	ADDED ITEM 6.																														
		E	3/2/83	REVISED PER ECO 8300084																														

[2] THIS ROM CAN BE USED ON ONLY USA - CANADA
AND JAPAN VERSION FOR SUBSTITUTE FOR ITEM 35.

1. SHEET 6&7 OF 7 ARE B-SIZE
ASSY DWG.
NOTES.

c b m	ENGINEERING	TITLE	DRAWN BY		DATE		SIZE	SHEET	
		P.C.B. ASSEMBLY	Y. HAGIWARA		1/1/81		E	1540001 - 1 or 7	
			CHKD		J. TANAKA				
					F. 26/1/81				

QUANTITY REQD PER	PART / DASH NO.	ITEM	PART NUMBER	DESCRIPTION	REF. DES	QTY	NOTES
1	03	01					
1	1	1	C 15400007	P.C. BOARD 31.5x15.5x6.62			MTL: GLASS EPOXY 6-10
1	2	1					
1	3	1					
1	4	1	C 15400008-01	SCHEMATIC DIAGRAM			
1	6	B	901229-03	IC 2364-197 ROM	UAB5		\$E000 ~ \$FFF
1	7	0	901435-01	IC MPS 6502 CPU	UCD5		\$C000 ~ \$FFFF
1	8	0	325302-01	2364-130 ROM	UAB4		\$E000 ~ \$FFFF
1	9	1	325303-01	2364-131 ROM	UAB5		\$E000 ~ \$FFFF
2	10	1	901437-01	MPS 6522 V/A	UAB1, UCD4		
4	11	1	901471-01	MPS 2114 RAM	UAB2,3, UBB2,3		
2	12	1	901521-01	74LS00	UAB7, UFS		
1	13	1	901521-21	74LS02	UFS		
1	14	1	901521-02	74LS04	INV.	UB6	
1	15	1	901521-24	74LS10	3 - NAND	UF3	
1	16	1	901521-30	74LS14	SCH. INV.	UC1	
1	17	1	901521-17	74LS42	DEC.	UB8	
2	18	2	901521-06	74LS74	D-FF	UE4, UF6	
1	19	1	901521-32	74LS86	2-Ex-OR	UG2	
1	20	1	901521-15	74LS133	13 - NAND	UC2	
1	21	1	901521-18	74LS139	Deep. P	UE2	
1	22	1	901521-28	74LS164	8 Bit Shift Reg	UD2	
1	23	1	901521-12	74LS165	8 Bit Shift Reg	UD3	
1	24	1	901521-40	74LS191	4 Bit Count.	UE3	
2	25	1	901521-26	74LS193	4 Bit Count.	UE7, UF4	
1	26	1	901521-45	74LS245	Bus Transceiver	UC3	
1	27	1	901522-32	7402		UC7	
2	28	2	901522-06	7406	INV. OC.	UD1, UF2	
1	29	1	901522-03	74177		UC6	
1	30	1	901510-01	9602		UG3	
1	31	1	901523-04	LM311		UH4	
2	32	2	901523-08	NE592		UH5, UH7	
1	33	8	901522-01	7417		UG4	
5	34	8	901521-54	74LS197		UC6	SUBSTITUTION FOR ITEM 29
2	35	5	901229-02	2364-186 ROM	UAB5		\$E000 ~ \$FFFF SUB. FOR ITEM 6.
5	36	8	901229-01	IC 2364-173 ROM	UAB5		\$E000 ~ \$FFFF SUB. FOR ITEM 6.
DRAWN BY:				DATE			
CHND: C. Takane				APPR:	/		
TITLE: PCB ASSY V1C-1540				DATE	/		
C B M ENGINEERING OSAKA JAPAN				SIZE	B	154000/-	2 or 7

30

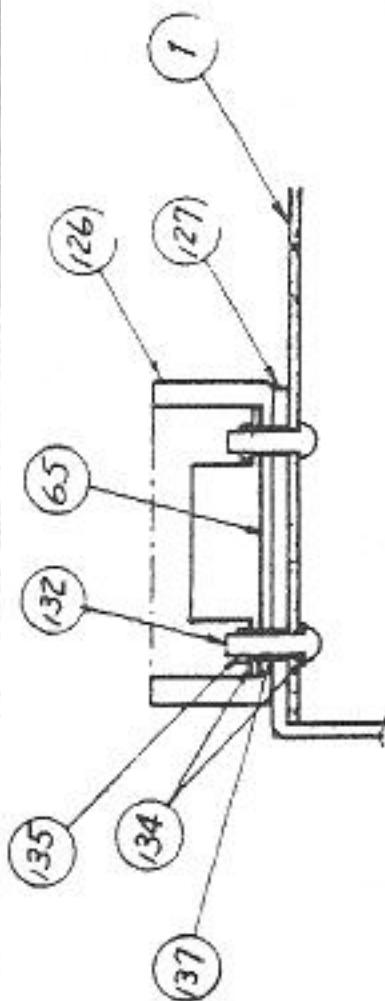
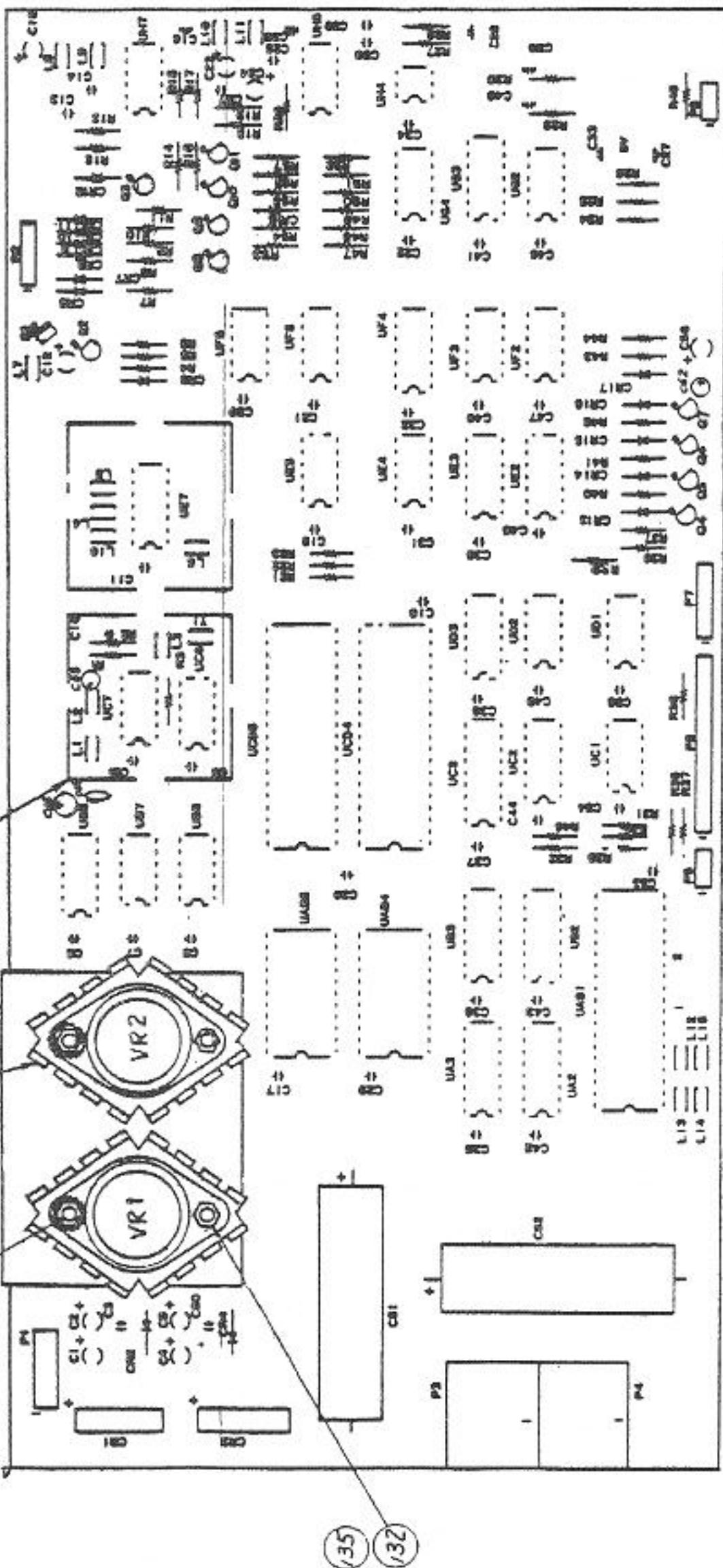
QUANTITY REQD PER	PART / DASH NO.	E	a	PART NUMBER	DESCRIPTION	REF. DES.	QTY	NOTES
03		01						
2	2 37 B	902671		TRANSISTOR NPN 2SC945	02, Q3			
5	5 38	902693-01		NPN 2SC1815	02, Q3	SUBSTITUTION FOR ITEM 37		
4	4 39	902679		NPN 2SD467	04-07			
5	5 40	902682		NPN 2SC2120	04-07	SUBSTITUTION FOR ITEM 38		
1	1 41	902720		PNP 2SA673	01			
4	4 42	902717		PNP 2SA733	08-Q11	SUBSTITUTION FOR ITEM 42		
5	5 43	902744-01		TRANSISTOR PNP 2SA1015	08-Q11	SUBSTITUTION FOR ITEM 42		
5	5 44	B	901522-30	IC 7407	U64	SUBSTITUTION FOR ITEM 33		
45								
6	6 46	B	900250-02	DIODE, SIGNAL IN14002	C7.4.13-16			
8	8 47	1	9002850-05	SIGNAL MG 713C	CR6-II, IT, B			
5	5 48		9002850-01	SIGNAL IN 4148	CR6-II, IT, B	SUBSTITUTION FOR ITEM 47		
1	1 49		325505-01	ZENER 3.3V 500mW ±5%	CR5	H23C-2		
5	5 50		325505-02	3.3V 500mW ±5%	CR5	H24A-1	SUB. FOR ITEM 49	
5	5 51		9002948-06	3.3V 500mW ±5%	CR5	IN5226B	SUB. FOR ITEM 49	
1	1 52		325506-01	5.1V 500mW ±5%	CR12	H25C-2		
5	5 53		9002948-11	ZENER 5.1V 500mW ±5%	CR12	IN5231	SUB. FOR ITEM 52	
1	1 54	1	9002756-01	BRIDGE 1.5A 50V	CR1	KBP005		
1	1 55	B	9002755-02	DIODE BRIDGE 4A 50V	CR3	KBL-02		
1	1 56							
1	1 57	B	9002556-02	CRYSTAL 16MHz	Y1			
1	1 58							
1	1 59	B	325513-01	COLL. INDUCTOR 2.2μH	L1			
2	2 60	B	325513-02	COLL. INDUCTOR 22μH	L8, L11			
3	3 61	B	325513-03	COLL. INDUCTOR 100μH	L7, L9, L10			
1	1 62							
1	1 63	B	901528-04	VOLTAGE REGULATOR 12V 1.5A	VR1	LM340-12		
1	1 64	B	901528-01	VOLTAGE REGULATOR 5V 3A	VR2	LM323		
2	2 65	B	904914	INSULATION MYLAR TO-3		ATTACHED WITH VOLT REGULATOR		
5	5 66	B	325551-01	INSULATION SILICONE TO-3		SUBSTITUTION FOR ITEM 65		
2	2 68	B	903361	CONNECTOR, DIN 6 PIN	P3, P4	HOSHIDENKI TCS4460-01-101		
3	3 70	B	904150-06	SOCKET IC LOW PRO. 40 PIN				
2	2 71	B	904153-03	SOCKET IC LOW PRO. 24 PIN				
22								
TITLE:				DRAWN BY:	DATE	SIZE	SHEET	
c b m ENGINEERING				CHKD: d. Takao	1/1/81	1/1	3 or 7	
OSAKA JAPAN				APPR:				

QUANTITY REQD PER	PART / DASH NO.	E	d	PART NUMBER	DESCRIPTION	REF. DES	QTY	NOTES
1	104-03-42-04							
1	1 173 B	325514-04		HEADER ASSY 2.5 PITCH RANG. 4PIN	P2	MOLEX	5049-04A&	
1	1 174 B	325515-06			P7		3094-06A	
1	1 175 B	325515-15			P6		3094-15A	
2	2 176 B	325515-03		2.5 PITCH RANG. 3PIN	P5, P8		3094-03A	
1	1 177 B	903316-04		HEADER ASSY 3.96 PITCH 4PIN	P1	MOLEX	5271-04A	
28								
1	1 179 B	900100-03		CAP. ELECTROLYTIC 220μF/25V	C65			
1	1 180 B	900101-44		CAP. ELECTROLYTIC 1000μF 16V	C52	AXIAL LEAD	#22x 52	
1	1 181 B	900101-45			C51	AXIAL LEAD	#22x 52	
2	2 182 B	900102-33		ELECTROLYTIC 1μF 25V	C2, C5			
2	2 183 B	900100-32			C1, C4			
1	1 184 B	900402-15		TANTALIUM 10μF 25V	C12			
1	1 185 B	900402-11		TANTALIUM 3.3μF 25V	C23			
1	1 186 B	900010-51		CERAMIC 68PF 50V	C10			
1	1 187 B	900010-52			C33		± 5%	
2	2 188 B	900010-53			C29, C49		± 5%	
3	3 189 B	900010-54			C16, C27, C50		± 5%	
1	1 190 B	900010-25		1000PF 50V	C26			
10	10 191 B	900010-20			0.1μF/ 50V	C3-9, 11, 14, 17-22	28-29-32, 34-48, 53-65, 67, 80, 81	
2	2 192 B	900010-14		CERAMIC 0.022μF 50V	C58, C59			
1	1 193 B	900100-40		ELECTROLYTIC 100μF 16V	C56			
2	2 194 B	900402-17		CAP. TANTALIUM 0.47μF 16V	C15, C24		± 20%	
1	1 195 B	900402-08		CAP. TANTALIUM 4.7μF/25V	C62			
1	1 196 B	900402-14		CAP. TANTALIUM 1μF/10V	C63			
1	1 197 B	900465-02		CAP. CERAMIC 0.033μF/ 25V	C64			
2	2 198 B	901550-108		RESISTOR, CARBON 1W 5%	R25, R30			
1	1 199 B	901550-56		RESISTOR, CARBON 1W 5% 4.7Ω	R3			
4	4 200 B	901550-89		RESISTOR, CARBON 1W 5% 15Ω	R18, R35, R6			
4	4 201 B	901550-52			R20Ω		R4, R17, 45	
5	5 202 B	901550-14			R30Ω		R1, R5, R20, R7	
6	6 203 B	901550-58			R47Ω		R27Ω, R25Ω, R55, R7	
5	5 205 B	901550-31			R50Ω		R9, R39-R42	
8	8 206 B	901550-01			R61Ω		R6, R31-34, R44, R5	
4	4 207 B	901550-53			R21-R23, R38			
6	6 208 B	901550-18		RESISTOR, CARBON 1W 5% 2.2KΩ	R41Ω, R51Ω, R66			
				DRAWN BY:	DATE:	SIZE:	SHEET	
				J. Takemoto	/ /	B	1540001-4 or 7	
				CHKD: J. Takemoto	1/1/1	APPR:		

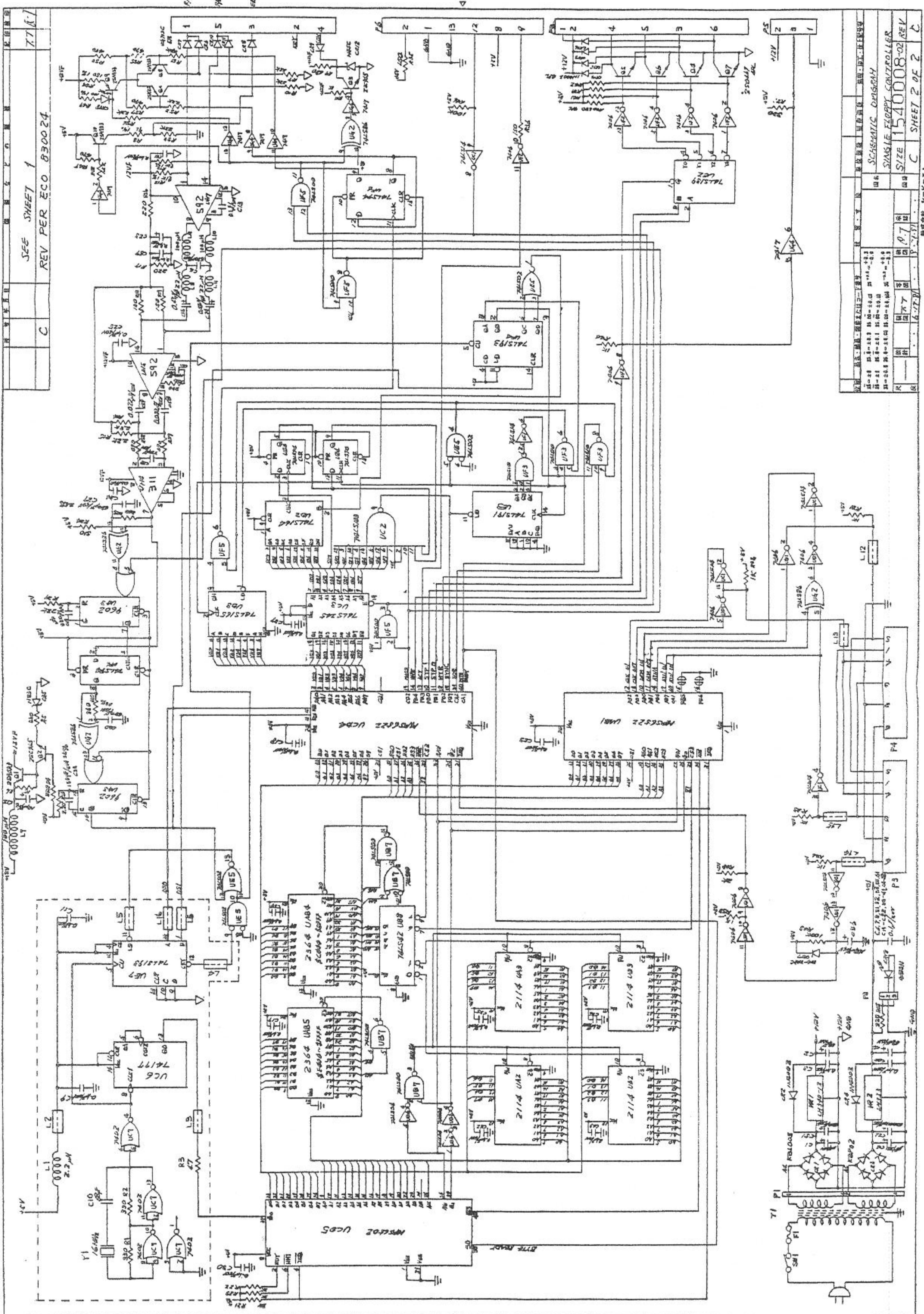
QUANTITY REQD PER PART / DASH NO.	E	d	PART NUMBER	DESCRIPTION	REF. DES	QTY	NOTES
104-03-02-01							
1	1409	B	901550-69	RESISTOR, CARBON $\frac{1}{2}W$ 5% 1.5K Ω	A68		
4	4110	B	901550-12	RESISTOR, METAL OXIDE $\frac{1}{2}W$ 1% 22K Ω	A7.10.29.53		
2	2111	B	901550-07	RESISTOR, CARBON $\frac{1}{2}W$ 5% 100K Ω	A63, A66		
1	1113	B	901751-43	RESISTOR, METAL OXIDE $\frac{1}{2}W$ 1% 91K Ω	A8		
1	1114	B	901751-18	RESISTOR, METAL OXIDE $\frac{1}{2}W$ 1% 100K Ω	A69		
1	1115	B	901751-44	RESISTOR, METAL OXIDE $\frac{1}{2}W$ 1% 150K Ω	A54		
2	2116	B	901751-45	RESISTOR, METAL OXIDE $\frac{1}{2}W$ 1% 9.1 K Ω	A12, A83		
117							
118							
119							
120	10	121	B	903025-01	FERRITE BEAD	12-16.12-216	
122							
123	2	124	B	4022048	SHIELD BOX		
2	2	125	B	4022047	SHIELD CAP		
2	2	126	B	1540023	HEAT SINK TO-3		
1	1	127	B	1540011	HEAT SINK REGULATOR		
%	%	128		904907-01	COMPOUND THER FOR HEAT SINK		
129							
130							
131	4	132	B	906800-02	SCREW PAN HEAD M3x10		
4	4	134	B	905655-03	EXTERNAL TOOTH WASHER M3		
4	4	135	B	905960-03	NUT HEX. M3		
136							
4	4	137	B	905477-02	TUBE VINYL $\frac{1}{2}3.5 \times 4.5$ mm		
138							
139							
140							
141							
142							
143							
144							
145							
TITLE: PC B ASSY V1C-1540				DRAWN BY:	DATE:		SPRINT
				C.H.D. C. Takada 5/1/71	/ /	/ /	
				CHKD: C. Takada 5/1/71	APPR:	/ /	5 or 7
c b m ENGINEERING OSAKA JAPAN							

REVISIONS			APPROVED
LTR	ZONE	DESCRIPTION	
		SEE SHEET 1	6-7

SEE SHEET 1



DRAWN BY:			DATE	
T. TAKADA			9/6/69	
CAB:				
DRAFT:				
DESIGN:				
APPROV:				
MATERIAL:			USED ON	RELEASER APPROV
			VIC-1540	VIC-1541
FINISH:				
SCALE & NAME			SHEET	REV
PCB ASSY.			6 OF 2	E
VIC-1540			1540001-%	B
JAPAN				



PART NO.	DESCRIPTION	REVISED PER ECO 830101							
		H	I	J	K	L	M	N	O
1540002-01	POWER SUPPLY ASSY VIC-1541 UL	A	Shhh	PICKUP/TRAN. RELEASE					
		B		CHANGED FILTER POWER CONNECTOR FOR CSA (ITEM 24 WAS ITEM 23)					
		C	1/4" P2	CHANGED FILTER POWER CONNECTOR FOR FCC (ITEM 25 WAS ITEM 23)					
		D	1/2" P2	CHANGED ACCESSORY OF TRANSFORMER					
		E	1/3" P2	CHANGED SCREW TO H3-6 FROM H3-8. ADDED DASH 06 THRU 10 AND ITEM 21.					
		F	1/4" P2	ADDED ITEM 8, 9 AND 63. ADDED SHEET 5 OF 5.					
		G	2/8" P2	REVISED PER ECO 830060					
		H	3/5" P3	REVISED PER ECO 830101					
	-06			VIC-1541 UL					

4. NO CHANGE QTY FOR ITEM 54 IF USED ITEM 6 OR 7.
 3. USE ONLY WHEN USED ITEM 8 OR 9.
 2. IF ITEM 8 OR 9 ARE USED THEN QTY FOR ITEM 54 WILL CHANGE FROM 7 TO 9 PCS AND USED WITH ITEM 63.
 1. SHEET 4 & 5 OF 5 ARE D-SIZE ASSY DWG.

NOTES.

NOTES.

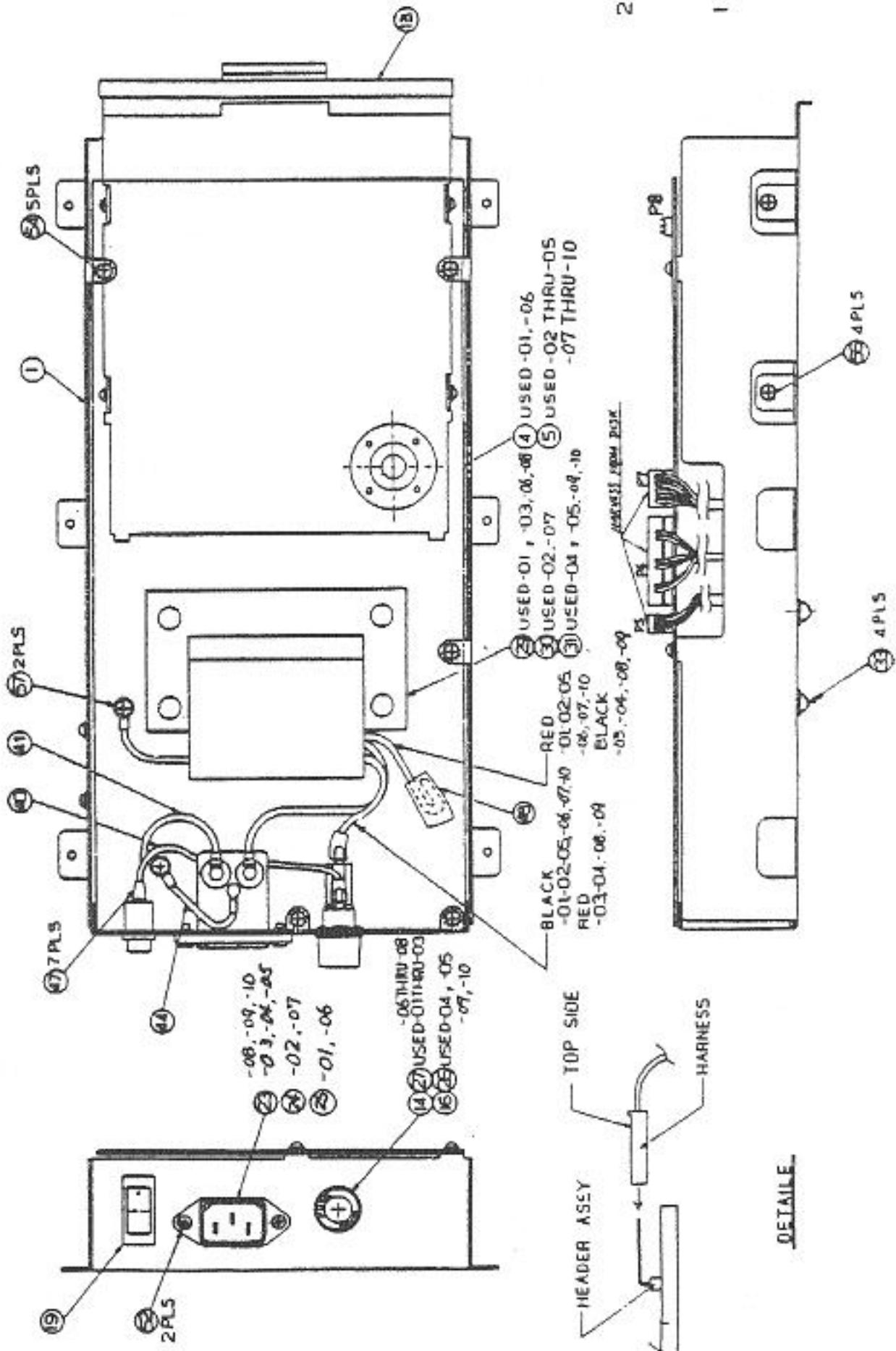
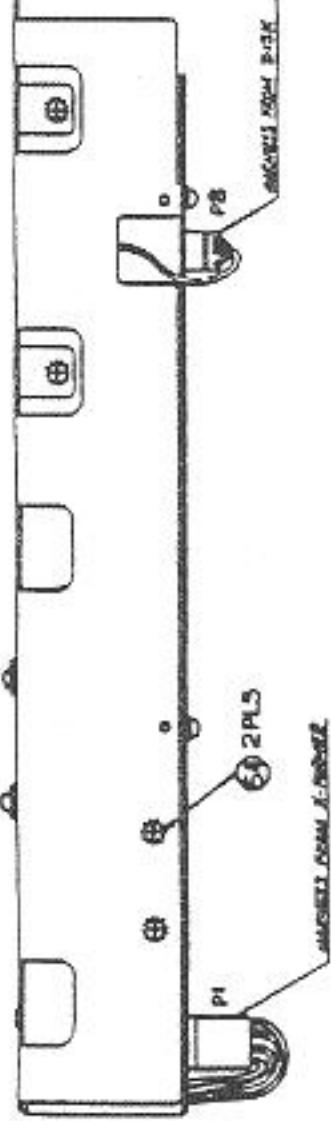
ASSY DWG.

Cbm ENGINEERINGS OSAKA JAPAN		TITLE POLE SUPPORT		DRAWN BY: Y. MIYAKE CHKD: APPR: DATE 1/1/1973 1/1/1973	SIZE B	1540002- 1 or 5	SHEET 1
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QUANTITY REQD PER	PART / DASH NO.	E	6	PART NUMBER	DESCRIPTION	REF. DES	G	NOTES
10	09 08 07 06 05 04 03 02 01	1	1	0 1540012	POWER CHASSIS			SUBSTITUTE FOR ITEM 2 . SEE NOTE 2
1		2	D	251153	POWER CHASSIS			SEE NOTE 3
		3						
		4	B/D	1540001 -01	PCB ASSY (FCC) UL			
		5	B/D	1540001 -02	PCB ASSY (FCC) UL			SUBSTITUTE FOR ITEM 8
		6	B/D	1540001 -03	PCB ASSY (FCC) UL			SUBSTITUTE FOR ITEM 9
		7	B/D	1540001 -04	PCB ASSY (FCC) UL			USED LOGIC ARRAY
		8	B	1540048 -01	PCB ASSY (FCC) UL			USED LOGIC ARRAY
		9	B	1540048 -02	PCB ASSY			
		10						
		11						
		12	B	325519 -01	FLOPPY DISK (BLACK)			SUBSTITUTE FOR ITEM 13
		13	B	325519 -02	FLOPPY DISK (BROWN)			
		14	B	903614 -01	FUSE HOLDER FH 032			
		15						
		16	B	903615 -01	FUSE HOLDER FH 033			
		17						
		18						
		19	B	904509 -01	SWITCH . ROTKER	S.W.1		
		20						SUBSTITUTE FOR ITEM 23 (TEKIN)
		21	B	325552 -01	FILTER POWER CONNECTOR			SUBSTITUTE FOR ITEM 23
		22						
		23						
		24						SUBSTITUTE FOR ITEM 23 (TEKIN 24-26)
		1	B	903467 -03	FILTER POWER CONNECTOR			
		25						
		1	B	903555 -20	FUSE SLO BLO 250V 1.0A			5.2 ⁴ X 20 mm
		26						6.3 ⁴ X 30 mm
		1	C	1540009 -01	POWER TRANSFORMER UL 120/100V	T 1		
		2	C	1540009 -02	POWER TRANSFORMER CSA	T 1		
		31						
		32						
		4	B	325548 -04	SCREW PAN HEAD WITH SPRING WASHER M5-10			TO BE ATTACHED WITH X-FORMER
		33						
		34						
		35						
		36						
TITLE				DRAWN BY 11/11/1984	DATE 11/11/1984	0416	SIZE 1/1	SHEET 1 of 5
cbm ENGINEERING OSAKA JAPAN				CHKD /	APPR.	/ /	B	1540002- 2 of 5

QUANTITY REQD PER	PART / DASH NO.	E	d	PART NUMBER	DESCRIPTION	REF. DES	QTY	NOTES
06	01	37						
	38							
1	40	B 200017 -03		LEAD WIRE (BLACK)				1015 ANG -18 L 150MM
1	41	B 200017 -04		LEAD WIRE (BLACK)				1015 ANG -18 L 80MM
1	42							
1	43							
1	44	B 1540010		GROUND CABLE ASSY				
	45							
7	46							
7	47	B 905476 -02		TUBING SHRINCBABLE				$\phi 5 \times 20$
1	48	B 905476 -04		TUBING SHRINCBABLE				$\phi 4 \times 40$
1	49							
50	50							
51	51							
2	52	B 906803-02		SCREW FLAT HEAD M3X8				FILTER CONNECTOR (2)
7	53							
7	54	B 325541-02		SCREW PAN HEAD M3X6 W/EXT TOOTH WASHER PCB (5), SEE NOTE 2				
7	55							
4	56	B 906610-03		SCREW PAN HEAD NO.6-32 UNI L10mm				FLOPPY DISK (4)
2	57	B 325542-02		SCREW PAN HEAD M4X6 W/EXT TOOTH WASHER				GROUND (2)
58	58							
59	59							
60	60							
61	61							
62	62							
63	63	B 1540051		METAL, L-ANGLE				SEE NOTE 2
64	64							
65	65							
66	66							
67	67							
68	68							
69	69							
70	70							
71	71							
72	72							
TITLE: POWER SUPPLY ASSY V1C-1540 DRAWN BY: Y. IMAGAWA DATE: 7/1/91								
c b m ENGINEERING OSAKA JAPAN DATE: 7/1/91 APPR: B 1540002-3 or 5								

REVISIONS		DESCRIPTION	DATE	UPGRADED
LTR	ZONE			
		SEC STREET. I	1/16/96	C-T



1. ALL OF HARNESS EXCEPT P1
SHOULD BE CONNECTED TO EACH
HEADER ASSY (SEE DETAIL).

2. ALL LEADS WILL HAVE A MINIMUM OF ONE WRAP AROUND TERMINALS PRIOR TO SOLDERING.

POWER SUPPLY ASSY
15400002 18

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